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PATENT APPLICATION  
Docket No. 11675.163.2



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Terry N. Williams

Serial No.: 09/761,375

) Art Unit

Filed: January 16, 2001

) 2882

For: BUFFERED RESIST PROFILE ETCH OF A  
FIELD EMISSION DEVICE STRUCTURE

Examiner: Jurie Yun

Confirmation No.: 5328

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AMENDMENT AND RESPONSE

Mail Stop: RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed from the United States Patent and Trademark Office on February 26, 2003, please enter the following amendments and remarks into the file of the above-identified application.

Amendments made herein are in accordance with the permissive rules signed by Steven Kunin, Deputy Commissioner for Patent Examination Policy (see <http://www.uspto.gov/web/offices/pac/dapp/opla/preognitice/revamdtprac.htm>) on January 31, 2003.